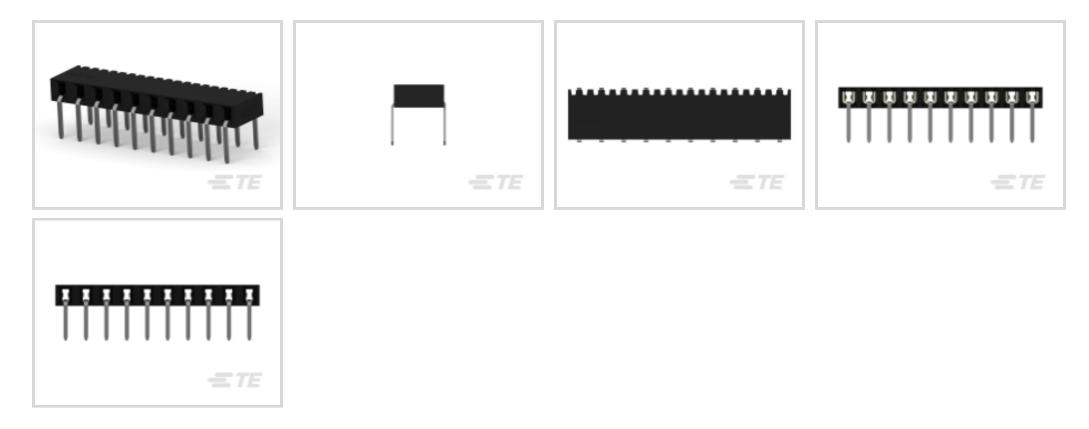
## 

### AMPMODU | AMPMODU 2 mm

TE Internal #: 1-2314936-0 PCB Mount Receptacle, Horizontal, Board-to-Board, 10 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal, AMPMODU 2 mm

#### View on TE.com >

#### Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Horizontal

Connector System: Board-to-Board

Number of Positions: 10

Number of Rows: 1

## Features



### **Product Type Features**

PCB Connector Assembly Type	PCB Mount Receptacle	
Connector System	Board-to-Board	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Loaded Positions	10	
PCB Mount Orientation	Horizontal	
Number of Positions	10	
Number of Rows	1	
Electrical Characteristics		
Dielectric Withstanding Voltage (Max)	650 VAC	
Operating Voltage	125 VAC	
Body Features		
Connector Profile	Standard	
Primary Product Color	Black	

PCB Mount Receptacle, Horizontal, Board-to-Board, 10 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal, AMPMODU 2 mm



## **Contact Features**

Mating Square Post Dimension	.5 mm[.02 in]		
PCB Contact Termination Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]		
Contact Layout	Inline		
Contact Underplating Material Thickness	1.27 μm[50 μin]		
PCB Contact Termination Area Plating Material Finish	Matte		
Contact Mating Area Plating Material Finish	Matte		
Contact Underplating Material	Nickel		
PCB Contact Termination Area Plating Material	Tin		
Contact Base Material	Phosphor Bronze		
Contact Mating Area Plating Material	Gold Flash		
Contact Mating Area Plating Material Thickness	.1 μm[3.94 μin]		
Contact Type	Socket		
Contact Current Rating (Max)	2 A		
Termination Features			
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]		
Rectangular Termination Post & Tail Width	.4 mm[.016 in]		
Termination Post & Tail Length	2.8 mm[.11 in]		
Termination Method to Printed Circuit Board	Through Hole - Solder		
Mechanical Attachment			
Mating Alignment	Without		
PCB Mount Retention	Without		
PCB Mount Alignment	Without		
Connector Mounting Type	Board Mount		
Housing Features			
Centerline (Pitch)	2 mm[.079 in]		
Housing Material	LCP (Liquid Crystal Polymer)		
Dimensions			
Connector Length	20 mm[.787 in]		
Connector Height	2.1 mm[.823 in]		
Connector Width	4.7 mm[.185 in]		
PCB Thickness (Recommended)	2.4 mm[.094 in]		

PCB Mount Receptacle, Horizontal, Board-to-Board, 10 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal, AMPMODU 2 mm



#### **Usage Conditions**

Housing Temperature Rating	High	
Operating Temperature Range	-40 – 125 °C[-40 – 257 °F]	
Operation/Application		
Assembly Process Feature	Pick and Place Cover	
Circuit Application	Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Features Packaging Type	Tape & Reel	

## Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023

(235)Candidate List Declared Against: JUNE2023 (235)Does not contain REACH SVHC

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Halogen Content

Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

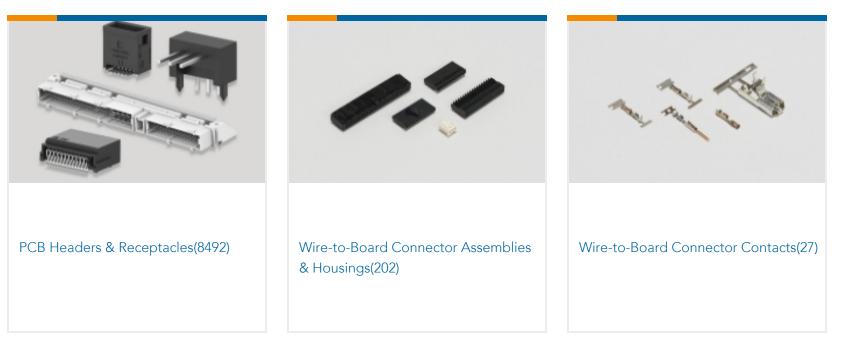
**&** For support call+1 800 522 6752

PCB Mount Receptacle, Horizontal, Board-to-Board, 10 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal, AMPMODU 2 mm





## Also in the Series AMPMODU 2 mm



# Customers Also Bought



TE Part #206966-9	TE Part #5-146280-1	TE Part #DT06-4S-C015	TE Part #41274
CABLE CLAMP KIT, BULK PKG	01 MODII HDR SRST B/A LF	PLG, 4P, GRY, E	250 FASTON,REC.,18-14 AWG,TPBR
AND THE		TE	
TE Part #1-1571999-6	TE Part #1438299-4	TE Part #1060-12-0166	TE Part #1060-20-0244
ADP0604=PIANO DIP SWITCH	GET MALE TERM, B, SN	PIN, SF, SIZE 12, 12-14, NI/SN	PIN, SF, SIZE 20, 16-22, AU/SN



PCB Mount Receptacle, Horizontal, Board-to-Board, 10 Position, 2 mm [.079 in] Centerline, Gold Flash, Through Hole - Solder, Signal, AMPMODU 2 mm



## Documents

CAD Files 3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_1-2314936-0\_A.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_1-2314936-0\_A.3d\_igs.zip

English

Customer View Model ENG\_CVM\_CVM\_1-2314936-0\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU 2mm BOARD-TO-BOARD RECEPTACLES

English

AMPMODU 2mm interconnection system QRG

English

**Product Specifications** Application Specification

English